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### **General Description**

The MAX3624 evaluation kit (EV kit) is an assembled demonstration board that provides convenient evaluation of the MAX3624 low-jitter, precision clock generator. The EV kit includes an on-board 25MHz crystal to allow immediate testing.

The EV kit includes switches to allow easy selection of different modes of operation. The reference input and clock outputs use SMA connectors and are AC-coupled to simplify connection to test equipment.

**Ordering Information** 

PART	TEMP RANGE	IC PACKAGE
MAX3624EVKIT	0°C to +85°C	32 TQFP-EP

### **Features**

- ♦ AC-Coupled I/Os for Ease of Testing
- ♦ Fully Assembled and Tested
- ♦ +3.3V Power-Supply Operation
- ♦ On-Board 25MHz Crystal

### **Part Suppliers**

SUPPLIER	WEBSITE	
NDK	www.ndk.com	

### Component List

DESIGNATION	QTY	DESCRIPTION
C1, C3, C4, C5, C7–C10, C19, C25–C30, C54	16	0.1µF ±10% ceramic capacitors (0402)
C2	1	10μF ±10% ceramic capacitor (0603)
C6, C57–C60	5	0.01µF ±10% ceramic capacitors (0402)
C22	1	27pF ±10% ceramic capacitor (0402)
C23	1	33pF ±10% ceramic capacitor (0402)
C65	1	4.7pF ±10% ceramic capacitor (0402)
J1, J3, J5	0	Not installed
J2, J48	2	Test points
J4	1	2-pin header, 0.1in centers
J13–J16, J18, J19, J36, J43	8	SMA connectors

DESIGNATION	QTY	DESCRIPTION
L1	1	2.7µH inductor
R1-R5, R7	6	150Ω ±5% resistors (0402)
R6, R8, R9	0	Not installed
R42	1	499Ω ±1% resistor (0402)
R57	1	49.9Ω ±1% resistor (0402)
R59	1	10.5Ω ±1% resistor (0402)
R61	1	36Ω ±5% resistor (0402)
SW1-SW3, SW11	4	SP3T switches
SW4, SW6–SW9 SW12, SW13, SW15	8	SPDT switches
TP6, TP7	2	Test points
U1	1	MAX3624UTJ+
Y1	1	25MHz crystal NDK EXS00A-AT00429
None	1	Shunt
None	1	PCB: MAX3624 Board, Rev B

### **Quick Start**

For evaluation of the MAX3624, configure the EV kit as

- 1) Determine which output is going to be evaluated and connect to the test equipment through SMA cables. Be sure not to leave any outputs unterminated, i.e., place  $50\Omega$  terminators on all unused outputs.
- 2) Connect a +3.3V power supply to J48 (VCC) and J2 (GND). Set the current limit to 200mA.
- 3) If the on-board crystal is used (IN\_SEL set high), the PLL divider should be set to divide by 25 (FB\_SEL1 and FB\_SEL0 set low) to achieve the standard output rates shown in Table 3.
- 4) Use Table 3 to set the output divider switches to achieve the output frequency desired.
- 5) Enable the output under test by setting the related output-enable switch, Qx\_OE, high.

### Table 1. Adjustment and Control Descriptions (see Quick Start first)

COMPONENT	NAME	FUNCTION	
J4	INDUCTOR SHUNT	J4 shunts the power-supply inductor. Normal operation is J4 shunted.	
SW1	SELB1	SW1 and SW2 set the output divider for the QB outputs. See Table 2 for more information.	
SW2	SELB0	SW1 and SW2 set the output divider for the QB outputs. See Table 2 for more information.	
SW3	SELA1	SW3 and SW11 set the output divider for the QA outputs. See Table 2 for more information.	
SW4	QAC_OE	Set high to enable the LVCMOS output, QA_C. Set low to disable QA_C.	
SW6	BYPASS	Set low to bypass the PLL. Set high to engage the PLL. Note that when the PLL is bypassed, the output dividers are automatically set to divide by 1.	
SW7	FB_SEL1	SW7 and SW8 set the PLL divider. See Table 3 for more information.	
SW8	FB_SEL0	SW7 and SW8 set the PLL divider. See Table 3 for more information.	
SW9	QA_OE	Set high to enable LVPECL output QA. Set low to force a logic zero at QA.	
SW11	SELA0	SW3 and SW11 set the output divider for the QA outputs. See Table 2 for more information.	
SW12	QB1_OE	Set high to enable LVPECL output QB1. Set low to force a logic zero at QB1.	
SW13	IN_SEL	Set high to select the crystal as the frequency source. Set low to select the REF_IN as the frequency source.	
SW15	QB0_OE	Set high to enable LVPECL output QB0. Set low to force a logic zero at QB0.	

**Table 2. PLL Divider Settings** 

INPUT		М	
FB_SEL1	FB_SEL0	DIVIDER	
LOW	LOW	÷25	
LOW	HIGH	÷24	
HIGH	LOW	÷32	
HIGH	HIGH	÷16	

**Table 3. Output Divider Settings** 

INPUT		NA/NB DIVIDER	OUTPUT FREQUENCY (MHz)
SELA1/SELB1	SELA0/SELB0		M = 25 AND XTAL = 25MHz
LOW	LOW	÷2	312.5
LOW	HIGH	÷3	208.33
HIGH	LOW	÷4	156.25
HIGH	HIGH	÷5	125
HIGH	OPEN	÷6	104.16
OPEN	HIGH	÷8	78.125
LOW	OPEN	÷10	62.5
OPEN	LOW	÷12	52.08
OPEN	OPEN	÷1	625

*Note:* 625MHz is beyond the maximum specified operating frequency.

### **Evaluates: MAX3624**

# 1AX3624 Evaluation Kit

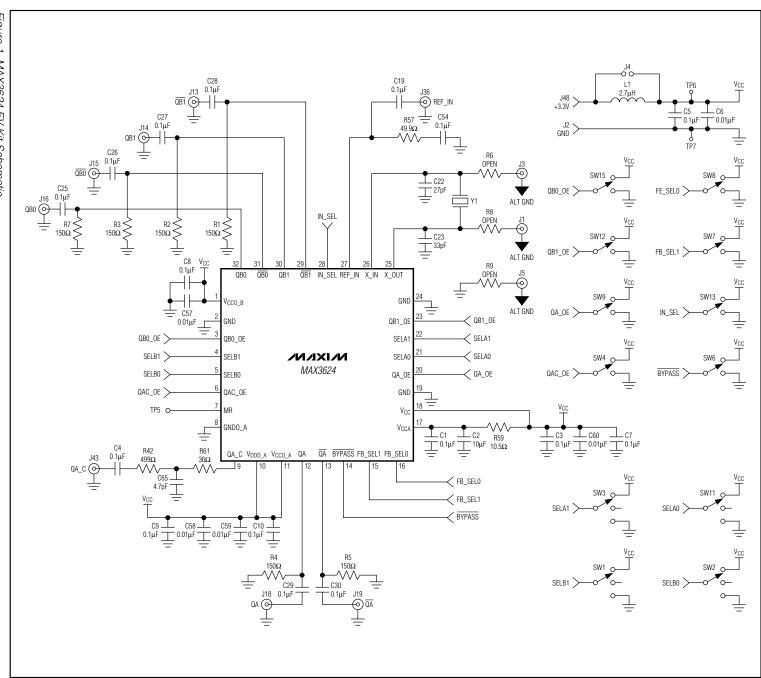


Figure 1. MAX3624 EV Kit Schematic

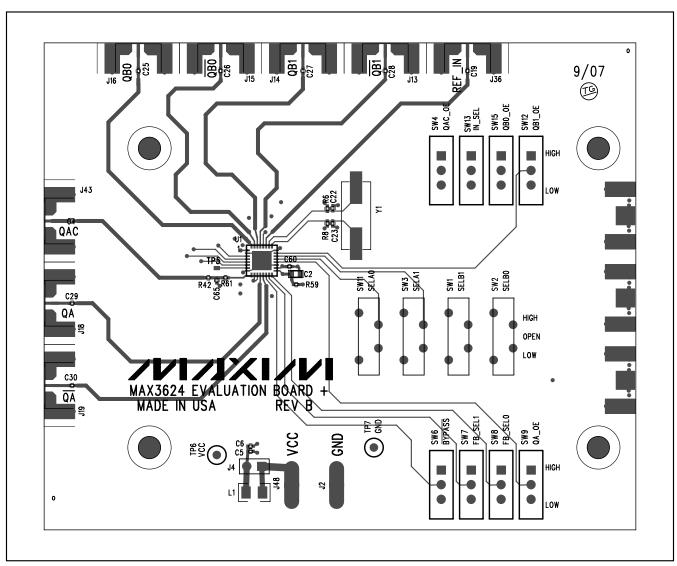


Figure 2. MAX3624 EV Kit Assembly Drawing—Top Side

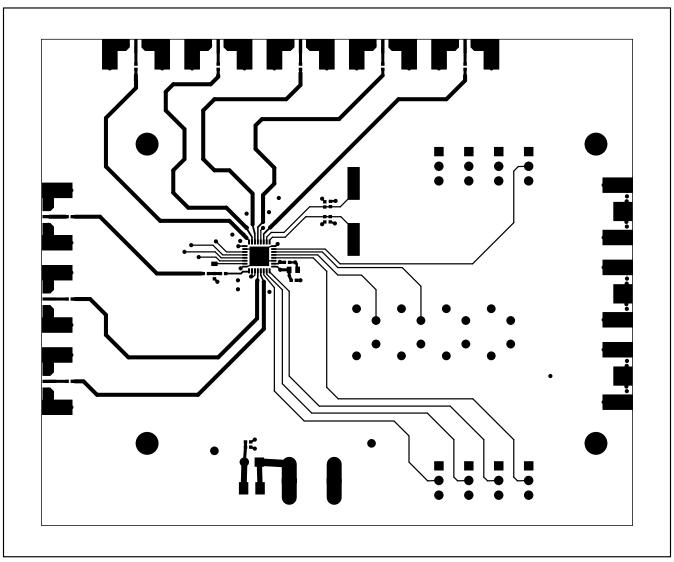


Figure 3. MAX3624 EV Kit Layout—Component Side

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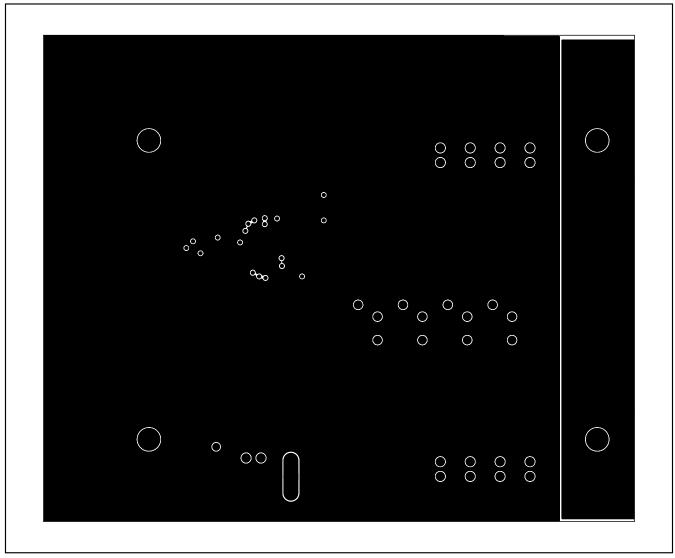


Figure 4. MAX3624 EV Kit Layout—Ground Plane

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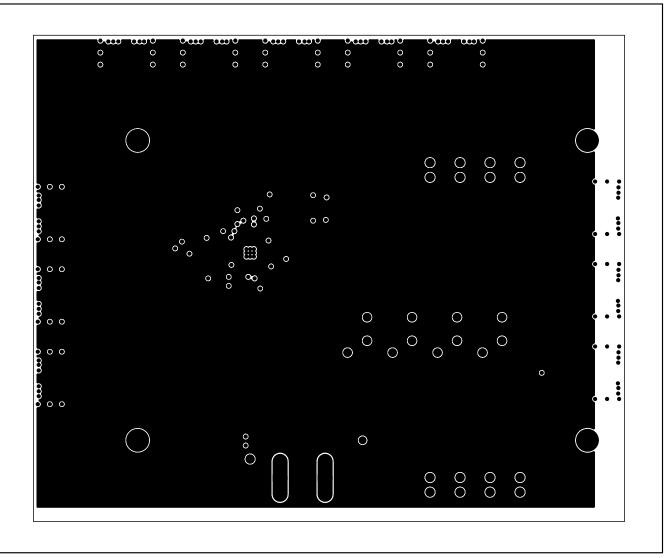


Figure 5. MAX3624 EV Kit Layout—Power Plane

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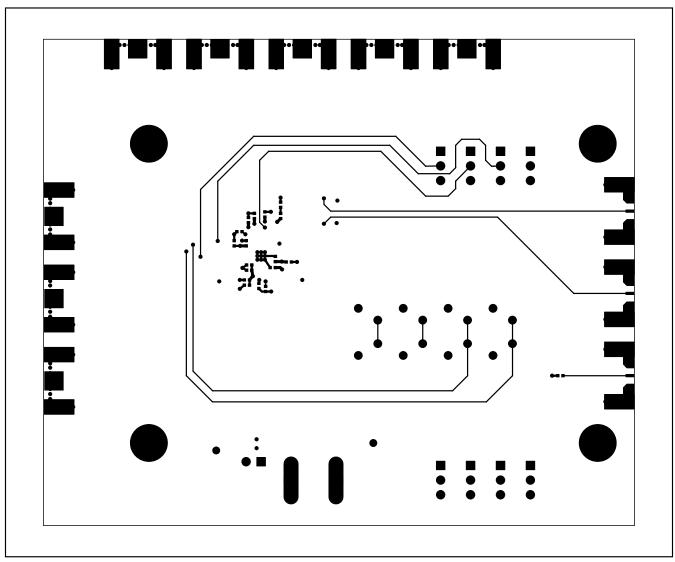


Figure 6. MAX3624 EV Kit Layout—Solder Plane

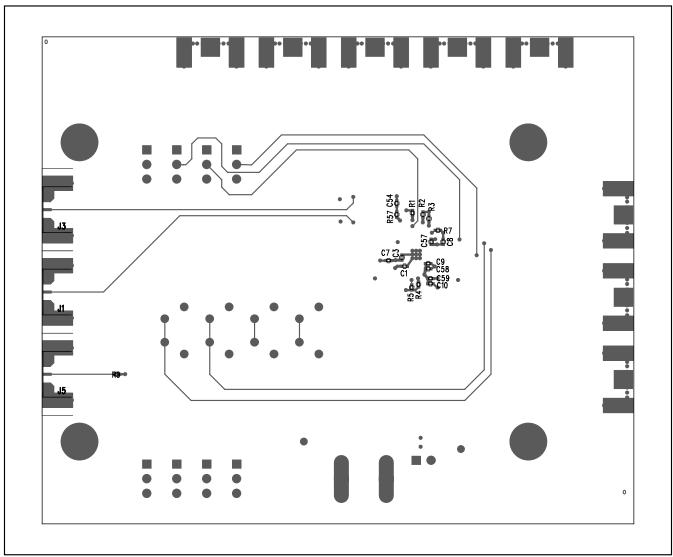


Figure 7. MAX3624 EV Kit Assembly Drawing—Bottom Side